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Buy style. Chip type Reliability Indicator: Established Reliability Failure Rate Level In Percent: 0.001 Terminal Length: Between 0.3 millimeters and 0.7 millimeters Body Widh: Between 1.8 millimeters and 2.2 millimeters Body Widh: Between 1.1 millimeters and 1.5 millimeters Body Widh: Schematic Diagram Designator: No common or grounded electrode (s) Insulation Resistance At Maximum Operating Temp: 10000 megohms Capacitance Value Per Section: 10000 megohms Capacitance Value Per Section: 10000 disfarads single section Nonderated Operating Temp: Between -55.0 degrees celsius and 125.0 degrees celsius Temparture Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius: 0.0.0 single section Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius: -5.00 +5.00 percent single section -5.00 vers.00 percent single section -6.00+5.00 percent single section Ceramic Insulation Resistance At Reference Temp: 10000.0 megohms	Body Style:
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N/a	
	N/a



Unit Of Measure:

Demilitarization:

No

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